

林亦波

长聘副教授 ◊ 设计自动化与计算系统系 ◊ 集成电路学院 ◊ 北京大学
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研究方向

面向超大规模集成电路设计自动化的建模和优化、深度学习及其应用、异构计算

教育经历

德克萨斯大学奥斯汀分校	2013 年 9 月 – 2018 年 5 月
博士学位, 电子与计算机工程系	
指导老师: David Z. Pan	
博士毕业论文: Bridging Design and Manufacturing Gap through Machine Learning and Machine-Generated Layout	
上海交通大学	2009 年 9 月 – 2013 年 7 月
学士学位, 微电子学院	

工作经历

北京大学 (Peking University)	2025 年 8 月至今
长聘副教授	
北京大学 (Peking University)	2019 年 6 月 – 2025 年 7 月
助理教授	
集成电路学院设计自动化与计算系统系 (自 2021 年 11 月)	
信息科学技术学院高能计算与应用中心	
德克萨斯大学奥斯汀分校 (University of Texas at Austin)	2018 年 7 月 – 2019 年 6 月
博士后	

授课经历

主讲	集成电路工程算法	研究生课程, 2023-2025 年
主讲	设计自动化与计算系统	研究生课程, 2022-2024 年
主讲	芯片设计自动化与智能优化	本科生课程, 2021-2025 年
主讲	计算概论 B	本科生课程, 2020-2022 年

奖项及荣誉

最佳论文提名	ICCAD	2025 年
最佳论文提名	DAC	2025 年
荣誉提名论文 (×2)	ISEDA	2025 年
最佳论文提名	ASPDAC	2025 年
最佳论文提名	ICCAD	2024 年
最佳论文 & 荣誉提名论文	ISEDA	2024 年
集成电路青年科技奖 (每年仅 1 位)	中国计算机学会容错计算专委	2023 年

首届最佳审稿人奖	ICCAD	2023 年
最佳论文 (4/205)	DATE	2023 年
最佳论文 (4/249)	DATE	2022 年
最佳论文提名	ICCAD	2022 年
最佳论文 (2/3495, 4 年)	TCAD	2021 年
最佳论文	ISPD	2020 年
最佳论文提名	ASPDAC	2020 年
最佳论文 (1/201) & 提名 (5/201)	DAC	2019 年
最佳论文提名	ISPD	2019 年
首届最佳论文	Integration, the VLSI Journal	2018 年
Franco Cerrina Memorial 最佳学生论文	SPIE	2016 年
A. Richard Newton Young Student Fellow	DAC	2014 年

学术服务

执行委员会成员

- 大会共同主席, ACM/IEEE International Symposium on Machine Learning for CAD (MLCAD), 2025 年
- 程序共同主席, ACM/IEEE International Symposium on Machine Learning for CAD (MLCAD), 2024 年
- 圆桌论坛主席, IEEE International Symposium of Electronics Design Automation (ISED), 2023 年–2024 年
- 财务主席, ACM/IEEE Workshop on Machine Learning for CAD (MLCAD), 2021 年–2023 年

期刊编委

- 副编辑, IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD), 2024 年至今
- 副编辑, ACM Transaction on Design Automation of Electronic Systems (TODAES), 2024 年至今
- 副编辑, Elsevier Integration, the VLSI Journal (Integration), 2024 年至今
- 客座编辑, ACM Transaction on Design Automation of Electronic Systems (TODAES) Special Issue on MLCAD, 2024 年
- 客座编辑, ACM Transaction on Design Automation of Electronic Systems (TODAES) Special Issue on MLCAD, 2022 年

赛题主席

- 赛题主席, 集成电路 EDA 设计精英挑战赛, 2021 年–2023 年

技术程序委员会成员

- ACM/IEEE Design Automation Conference (DAC): 2020
- IEEE/ACM International Conference on Computer-Aided Design (ICCAD): 2018 – 2021, 2023
- Design, Automation and Test in Europe Conference (DATE): 2025
- IEEE International Conference on Computer Design (ICCD): 2019

- IEEE/ACM Asia and South Pacific Design Automation Conference (ASPDAC): 2021 – 2022
- ACM International Symposium on Physical Design (ISPD): 2020, 2025
- ACM/IEEE Workshop on Machine Learning for CAD (MLCAD): 2021
- ACM Great Lakes Symposium on VLSI (GLVLSI): 2024
- Workshop on Synthesis And System Integration of Mixed Information technologies (SASIMI): 2021
- IEEE Electron Devices Technology and Manufacturing Conference (EDTM): 2021
- IEEE International Conference on Artificial Intelligence Circuits and Systems (AICAS): 2022.

期刊审稿人

- IEEE Transaction on Computer-Aided Design of Integrated Circuits and Systems (TCAD)
- IEEE Transactions on Computers (TC)
- ACM Transaction on Design Automation of Electronic Systems (TODAES)
- SPIE Journal of Micro/Nanolithography, MEMS, and MOEMS (JM3)
- Elsevier, Integration, the VLSI Journal (Integration)

其他志愿服务

- ACM SIGDA 网站管理负责人, 2021 年至今

10 篇代表性论文

按时间倒序排列。标 * 表示通讯作者。

1. Yifan Chen, Zaiwen Wen, Yun Liang and **Yibo Lin***, “[Stronger Mixed-Size Placement Backbone Considering Second-Order Information](#)”, IEEE/ACM International Conference on Computer-Aided Design (ICCAD), San Francisco, CA, Oct 29-31, 2023.
2. Haoyi Zhang, Xiaohan Gao, Haoyang Luo, Jiahao Song, Xiyuan Tang, Junhua Liu, **Yibo Lin***, Runsheng Wang and Ru Huang, “[SAGERoute: Synergistic Analog Routing Considering Geometric and Electrical Constraints with Manual Design Compatibility](#)”, IEEE/ACM Proceedings Design, Automation and Test in Europe (DATE), Antwerp, Belgium, Apr 17-19, 2023. (**Best Paper Award**)
3. Jing Mai, Jiarui Wang, Zhixiong Di and **Yibo Lin***, “[Multi-Electrostatic FPGA Placement Considering SLICEL-SLICEM Heterogeneity, Clock Feasibility, and Timing Optimization](#)”, IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD), Sep, 2023.
4. Zizheng Guo, Tsung-Wei Huang and **Yibo Lin***, “[Accelerating Static Timing Analysis using CPU-GPU Heterogeneous Parallelism](#)”, IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD), Jun, 2023.
5. Qipan Wang, Xiaohan Gao, **Yibo Lin***, Runsheng Wang and Ru Huang, “[DeePEB: A Neural Partial Differential Equation Solver for Post Exposure Baking Simulation in Lithography](#)”, IEEE/ACM International Conference on Computer-Aided Design (ICCAD), San Diego, CA, Nov 01-03, 2022. (**Best Paper Nomination**)
6. Zizheng Guo and **Yibo Lin***, “[Differentiable-Timing-Driven Global Placement](#)”, ACM/IEEE Design Automation Conference (DAC), San Francisco, CA, Jul 10-14, 2022.

7. Siting Liu, Peiyu Liao, Zhitang Chen, Wenlong Lv, **Yibo Lin*** and Bei Yu*, “[FastGR: Global Routing on CPU-GPU with Heterogeneous Task Graph Scheduler](#)”, IEEE/ACM Proceedings Design, Automation and Test in Europe (DATE), Antwerp, Belgium, Mar 14-23, 2022. (**Best Paper Award**)
8. Zizheng Guo, Jing Mai and **Yibo Lin***, “[Ultrafast CPU/GPU Kernels for Density Accumulation in Placement](#)”, ACM/IEEE Design Automation Conference (DAC), San Francisco, CA, Dec 05-09, 2021.
9. Zizheng Guo, Tsung-Wei Huang and **Yibo Lin***, “[A Provably Good and Practically Efficient Algorithm for Common Path Pessimism Removal in Large Designs](#)”, ACM/IEEE Design Automation Conference (DAC), San Francisco, CA, Dec 05-09, 2021.
10. **Yibo Lin***, Zixuan Jiang, Jiaqi Gu, Wuxi Li, Shounak Dhar, Haoxing Ren, Brucek Khailany and David Z. Pan, “[DREAMPlace: Deep Learning Toolkit-Enabled GPU Acceleration for Modern VLSI Placement](#)”, IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD), Apr, 2021. (**Best Paper Award**)

发明专利列表

- [P18] 吴恒, 卢浩然, 江循, 孙嘉诚, 王润声, **林亦波**, 黄如, “半导体结构的制备方法、半导体结构、器件及设备”, 中国专利, CN2024101785421, Feb 09, 2024. (submitted)
- [P17] **林亦波**, 郭资政, 张作栋, 江循, 王润声, 黄如, “电路门级逻辑仿真方法、装置、计算机设备和存储介质”, 中国专利, CN2023112735027, Jan 09, 2024. (submitted)
- [P16] 余备, 廖培宇, **林亦波**, “一种基于 MoreauEnvelope 近似线长模型的大规模解析布局方法”, 中国专利, CN2023111300780, Nov 28, 2023. (submitted)
- [P15] 王润声, 张作栋, **林亦波**, 黄如, “一种基于解析模型的晶体管老化应力计算方法”, 中国专利, CN202310843291X, Oct 13, 2023. (submitted)
- [P14] **林亦波**, 高笑涵, 张昊懿, 王润声, 黄如, “一种多驱动能力的集成电路标准单元版图迁移的方法”, 中国专利, CN2023101249631, Mar 28, 2023.
- [P13] **林亦波**, 王启盼, 王润声, 黄如, “一种集成电路微带线传输线自动化分析设计方法”, 中国专利, CN2023100496576, Mar 17, 2023.
- [P12] **林亦波**, 郭资政, 谷丰, “一种 GPU 加速构建最小直角斯坦纳树的芯片布线方法”, 中国专利, CN2022112858018, Jan 03, 2023. (submitted)
- [P11] **林亦波**, 高笑涵, 张昊懿, 王润声, 黄如, “可处理电学和几何约束的模拟电路布线自动化方法及系统”, 中国专利, CN2022114229951, Dec 20, 2022.
- [P10] 郭资政, **林亦波**, 黄琮蔚, “一种集成电路静态时序分析中的路径分析方法”, 中国专利, CN2021103772507, Oct 18, 2022. (submitted)
- [P9] **林亦波**, 郭资政, “一种可微分时序驱动的芯片布局优化方法”, 中国专利, CN2022107930171, Aug 05, 2022.
- [P8] **林亦波**, 张昊懿, 高笑涵, 王润声, 黄如, “一种用于模拟电路版图布线的交互式编辑方法及工具”, 中国专利, CN2022100363194, May 17, 2022.
- [P7] **林亦波**, 麦景, “基于多电场模型的时钟驱动 FPGA 芯片全局布局方法”, 中国专利, CN2022102058942, Apr 12, 2022.

- [P6] 林亦波, 张作栋, 郭资政, 王润声, 黄如, “一种老化及涨落感知的动态时序分析方法”, 中国专利, CN2021115414669, Apr 5, 2022. (submitted)
- [P5] 林亦波, 张作栋, 郭资政, 王润声, 黄如, “一种基于事件传播的动态时序分析方法”, 中国专利, CN2021109930951, Dec 24, 2021.
- [P4] 林亦波, 郭资政, 黄琮蔚, “一种 GPU 加速计算的集成电路无悲观路径分析方法”, 中国专利, CN2021110703249, Dec 24, 2021.
- [P3] 麦景, 郭资政, 林亦波, “一种集成电路设计中器件密度分布的计算方法”, 中国专利, CN2021105506486, Aug 27, 2021.
- [P2] 高笑涵, 林亦波, 刘鸣杰, 潘志刚, “一种交互式模拟电路版图编辑方法及系统”, 中国专利, CN2021101747163, Jun 18, 2021.
- [P1] 郭资政, 黄琮蔚, 林亦波, “一种 GPU 加速计算的集成电路静态时序分析方法”, 中国专利, CN2020111436325, Jan 22, 2021.

著作及论文列表

书籍章节

- [B3] **Yibo Lin**, Zizheng Guo and Jing Mai, “[Deep Learning Framework for Placement](#)”, Machine Learning Applications in Electronic Design Automation, Springer, 2023, edited by Haoxing Ren and Jiang Hu. (**Invited Book Chapter**)
- [B2] Haoyu Yang, **Yibo Lin** and Bei Yu, “[Machine Learning for Mask Synthesis and Verification](#)”, Machine Learning Applications in Electronic Design Automation, Springer, 2023, edited by Haoxing Ren and Jiang Hu. (**Invited Book Chapter**)

会议及期刊论文 (标 * 表示通讯作者)

论文成果包括: DAC (29 篇), ICCAD (24 篇), IEEE TCAD (31 篇), DATE (15 篇), ...

- [J210] Zhenkun Lin, **Yibo Lin**, Genggeng Liu* and Gang Du, “[URoute: Universal Routability Prediction](#)”, IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD), 2026. (accepted)
- [C209] Zizheng Guo, Haichuan Liu, Xizhe Shi, Shenglu Hua, Zuodong Zhang, Chunyuan Zhao, Runsheng Wang and **Yibo Lin***, “HeteroSTA: A CPU-GPU Heterogeneous Static Timing Analysis Engine with Holistic Industrial Design Support”, IEEE/ACM Asia and South Pacific Design Automation Conference (ASPDAC), Hong Kong, Jan, 2026. (accepted)(**Invited paper**)
- [C208] Xizhe Shi, Zizheng Guo, **Yibo Lin***, Zuodong Zhang, Yun Liang and Runsheng Wang*, “HeteroLatch: A CPU-GPU Heterogeneous Latch-Aware Timing Analysis Engine”, IEEE/ACM Asia and South Pacific Design Automation Conference (ASPDAC), Hong Kong, Jan, 2026. (accepted)
- [C207] Kairong Guo, Haoran Lu, Rui Guo, Jiarui Wang, Chunyuan Zhao, Heng Wu, Runsheng Wang and **Yibo Lin***, “Standard Cell Layout Synthesis for Dual-Sided 3D-Stacked Transistors”, IEEE/ACM Asia and South Pacific Design Automation Conference (ASPDAC), Hong Kong, Jan, 2026. (accepted)
- [C206] Weijian Fan, Haoyi Zhang, Weibin Lin, Runsheng Wang and **Yibo Lin***, “MOSTAR: Multi-Stage Hierarchical Bayesian Optimization for Substructure-Aware High-Dimensional Analog

- Circuit Sizing”, IEEE/ACM Asia and South Pacific Design Automation Conference (ASPDAC), Hong Kong, Jan, 2026. (accepted)
- [C205] Chenhao Xue, Kezhi Li, Jiaxing Zhang, Yi Ren, Zhengyuan Shi, Chen Zhang, **Yibo Lin**, Lining Zhang, Qiang Xu and Guangyu Sun*, “AC-Refiner: Efficient Arithmetic Circuit Optimization Using Conditional Diffusion Models”, IEEE/ACM Asia and South Pacific Design Automation Conference (ASPDAC), Hong Kong, Jan, 2026. (accepted)
- [J204] Siting Liu, Ziyi Wang, Fangzhou Liu, **Yibo Lin**, Bei Yu* and Martin Wong, “[Sign-off Timing Considerations via Concurrent Routing Topology Optimization](#)”, IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD), 2025. (accepted)
- [J203] Zhenkun Lin, Genggeng Liu*, Xing Huang, **Yibo Lin**, Jixin Zhang, Wenhao Liu and Ting-Chi Wang, “[A Unified Deep Reinforcement Learning Approach for Constructing Rectilinear and Octilinear Steiner Minimum Tree](#)”, IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD), 2025. (accepted)
- [J202] Bingyang Liu, Haoyi Zhang, Xiaohan Gao, Zichen Kong, Xiyuan Tang, **Yibo Lin***, Runsheng Wang and Ru Huang, “[LayoutCopilot: An LLM-powered Multi-agent Collaborative Framework for Interactive Analog Layout Design](#)”, IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD), 2025. (accepted)
- [J201] Jingchen Zhu, Chenhao Xue, Yiqi Chen, Zhao Wang, Chen Zhang, Yu Shen, Yifan Chen, Zekang Cheng, Yu Jiang, Tianqi Wang, **Yibo Lin**, Wei Hu, Bin Cui, Runsheng Wang, Yun Liang and Guangyu Sun*, “[Theseus: Exploring Efficient Wafer-Scale Chip Design for Large Language Models](#)”, IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD), 2025. (accepted)
- [J200] Yajuan Su, Zixi Liu, **Yibo Lin**, Xiaojing Su, Yuqin Wang, Xin Hong, Yujie Jiang, Pengyu Ren and Yayi Wei, “[A Post-Routing Layout Optimization Framework for Lithography Process Window Enlargement](#)”, IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD), 2025. (accepted)
- [J199] Jing Mai, Chunyuan Zhao, Zuodong Zhang, Zhixiong Di, Runsheng Wang and **Yibo Lin***, “[LEGALM 2.0: A Versatile Augmented Lagrangian Method-Based Methodology for Mixed-Cell-Height Legalization](#)”, IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD), 2025. (accepted)
- [C198] Chunyuan Zhao, Jiarui Wang, Xun Jiang, Jincheng Lou and **Yibo Lin***, “GTA: GPU-Accelerated Track Assignment with Lightweight Lookup Table for Conflict Detection”, IEEE/ACM International Conference on Computer-Aided Design (ICCAD), Munich, Germany, Oct, 2025. (**Best Paper Nomination**)
- [C197] Yufan Du, Zizheng Guo, Runsheng Wang and **Yibo Lin***, “Differentiable Physical Optimization”, IEEE/ACM International Conference on Computer-Aided Design (ICCAD), Munich, Germany, Oct, 2025.
- [C196] Yuhao Ji, Yuntao Lu, Zuodong Zhang, Zizheng Guo, **Yibo Lin** and Bei Yu*, “DiffCCD: Differentiable Concurrent Clock and Data Optimization”, IEEE/ACM International Conference on Computer-Aided Design (ICCAD), Munich, Germany, Oct, 2025.
- [C195] Yuan Pu, Yuhao Ji, Siying Yu, Zuodong Zhang, Zizheng Guo, Zhuolun He, **Yibo Lin**, David Z. Pan and Bei Yu*, “GPU Acceleration for Versatile Buffer Insertion”, IEEE/ACM

- International Conference on Computer-Aided Design (ICCAD), Munich, Germany, Oct, 2025.
- [C194] Yi Ren, Baokang Peng, Chenhao Xue, Kairong Guo, Yukun Wang, Guoyao Cheng, **Yibo Lin**, Lining Zhang and Guangyu Sun*, “Orthrus: Dual-Loop Automated Framework for System-Technology Co-Optimization”, IEEE/ACM International Conference on Computer-Aided Design (ICCAD), Munich, Germany, Oct, 2025.
- [C193] Haichuan Liu, Zizheng Guo, Runsheng Wang and **Yibo Lin***, “IncreGPUSTA: GPU-Accelerated Incremental Static Timing Analysis for Iterative Design Flows”, IEEE/ACM International Conference on Computer-Aided Design (ICCAD), Munich, Germany, Oct, 2025.
- [C192] Tianxiang Zhu, Qipan Wang, **Yibo Lin*** and Runsheng Wang*, “High-Resolution Full-Chip Thermal Resistance Extraction of BEOL Interconnects in 3-D ICs Considering Detailed Via Connectivity”, IEEE/ACM International Conference on Computer-Aided Design (ICCAD), Munich, Germany, Oct, 2025.
- [C191] Chenchen Zhao, Zhengyuan Shi, Xiangyu Wen, Chengjie Liu, Yi Liu, Yunhao Zhou, Yuxiang Zhao, Hefei Feng, Yinan Zhu, Waa Gwok-Wan, Xin Cheng, Weiyu Chen, Yongqi Fu, Chujie Chen, Chenhao Xue, Ying Wang, **Yibo Lin**, Jun Yang, Ning Xu, Xi Wang and Qiang Xu*, “MMCCircuitEval: A Comprehensive Multimodal Circuit-Focused Benchmark for Evaluating LLMs”, IEEE/ACM International Conference on Computer-Aided Design (ICCAD), Munich, Germany, Oct, 2025.
- [C190] Yuxiang Zhao, Zhuomin Chai, Xun Jiang, Qiang Xu, Runsheng Wang and **Yibo Lin***, “DeepLayout: Learning Neural Representations of Circuit Placement Layout”, International Conference on Machine Learning (ICML), Vancouver, Canada, Jul 13-19, 2025.
- [C189] Lijie Zeng, Jiatai Sun, Xiao Wu, Dan Niu, Tianshi Wang, **Yibo Lin**, Zuochang Ye and Zhou Jin*, “G-SpNN: GPU-Accelerated Passivity Enforcement for S-Parameter Modeling with Neural Networks”, ACM/IEEE Design Automation Conference (DAC), San Francisco, CA, Jun 22-25, 2025.
- [C188] Ziyang Yu, Peng Xu, Zixiao Wang, Binwu Zhu, Qipan Wang, **Yibo Lin**, Runsheng Wang, Bei Yu* and Martin Wong, “SDM-PEB: Spatial-Depthwise Mamba for Enhanced Post-Exposure Bake Simulation”, ACM/IEEE Design Automation Conference (DAC), San Francisco, CA, Jun 22-25, 2025.
- [C187] Zizheng Guo, Yanqing Zhang, Runsheng Wang, **Yibo Lin** and Haoxing Ren, “GEM: GPU-Accelerated Emulator-Inspired RTL Simulation”, ACM/IEEE Design Automation Conference (DAC), San Francisco, CA, Jun 22-25, 2025. (**Best Paper Nomination**)
- [C186] Xun Jiang, Haoran Lu, Yuxuan Zhao, Jiarui Wang, Zizheng Guo, Heng Wu, Bei Yu, Sung Kyu Lim, Runsheng Wang, Ru Huang and **Yibo Lin***, “A Systematic Approach for Multi-Objective Double-Side Clock Tree Synthesis”, ACM/IEEE Design Automation Conference (DAC), San Francisco, CA, Jun 22-25, 2025.
- [C185] Jiarui Wang, Yanjing Liu and **Yibo Lin***, “Synergistic Die-Level Router for Multi-FPGA System with Time-Division Multiplexing Optimization”, ACM/IEEE Design Automation Conference (DAC), San Francisco, CA, Jun 22-25, 2025.
- [C184] Yifan Chen, Jing Mai, Zuodong Zhang and **Yibo Lin***, “RUPlace: Optimizing Routability via Unified Placement and Routing Formulation”, ACM/IEEE Design Automation Conference (DAC), San Francisco, CA, Jun 22-25, 2025.

- [J183] Yuxiang Zhao, Zhuomin Chai, Xun Jiang, **Yibo Lin***, Runsheng Wang and Ru Huang, “[PDNNet: PDN-Aware GNN-CNN Heterogeneous Network for Dynamic IR Drop Prediction](#)”, IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD), Jun, 2025.
- [J182] Rui Guo, Haoran Lu, Jiacheng Sun, Xun Jiang, Lining Zhangm, Ming Li, **Yibo Lin**, Runsheng Wang, Heng Wu* and Ru Huang, “[Design Optimization of Flip FET Standard Cells With Dual-Sided Pins for Ultimate Scaling](#)”, IEEE Transactions on Electron Devices (TED), Jun, 2025.
- [C181] Haoyi Zhang, Shizhao Sun, **Yibo Lin**, Runsheng Wang and Jiang Bian, “[AnalogXpert: Automating Analog Topology Synthesis by Incorporating Circuit Design Expertise into Large Language Models](#)”, IEEE/ACM International Symposium of EDA (ISEDA), Hong Kong, May 9-12, 2025.
- [C180] Yufan Du, Zizheng Guo, Yang Hsu, Zhili Xiong, Seunggeun Kim, David Z. Pan, Runsheng Wang and **Yibo Lin***, “[Addressing Continuity and Expressivity Limitations in Differentiable Physical Optimization: A Case Study in Gate Sizing](#)”, IEEE/ACM International Symposium of EDA (ISEDA), Hong Kong, May 9-12, 2025. (**Honorable Mention Paper Award**)
- [C179] Kairong Guo and **Yibo Lin***, “[Multi-Row Standard Cell Layout Synthesis with Enhanced Scalability](#)”, IEEE/ACM International Symposium of EDA (ISEDA), Hong Kong, May 9-12, 2025.
- [C178] Qipan Wang, **Yibo Lin***, Runsheng Wang and Ru Huang, “[ATSim3.5D: A Multiscale Thermal Simulator for 3.5D-IC Systems based on Nonlinear Multigrid Method](#)”, IEEE/ACM International Symposium of EDA (ISEDA), Hong Kong, May 9-12, 2025. (**Honorable Mention Paper Award**)
- [C177] Chenhao Xue, Yi Ren, Jinwei Zhou, Kezhi Li, Chen Zhang, **Yibo Lin**, Lining Zhang, Qiang Xu and Guangyu Sun*, “[DOMAC: Differentiable Optimization for High-Speed Multipliers and Multiply-Accumulators](#)”, IEEE/ACM International Symposium of EDA (ISEDA), Hong Kong, May 9-12, 2025.
- [C176] Yi Ren, Chenhao Xue, Jiaxing Zhang, Chen Zhang, Qiang Xu, **Yibo Lin** and Guangyu Sun*, “[DiffuSE: Cross-Layer Design Space Exploration of DNN Accelerator via Diffusion-Driven Optimization](#)”, IEEE/ACM International Symposium of EDA (ISEDA), Hong Kong, May 9-12, 2025.
- [C175] Haoran Lu, Xun Jiang, Yanbang Chu, Ziqiao Xu, Rui Guo, Wanyue Peng, **Yibo Lin**, Runsheng Wang, Heng Wu* and Ru Huang, “[A Tale of Two Sides of Wafer: Physical Implementation and Block-Level PPA on Flip FET with Dual-sided Signals](#)”, IEEE/ACM Proceedings Design, Automation and Test in Europe (DATE), Lyon, France, Mar 31, 2025.
- [C174] Tianxiang Zhu, Qipan Wang, **Yibo Lin***, Runsheng Wang and Ru Huang, “[MORE-Stress: Model Order Reduction based Efficient Numerical Algorithm for Thermal Stress Simulation of TSV Arrays in 2.5D/3D IC](#)”, IEEE/ACM Proceedings Design, Automation and Test in Europe (DATE), Lyon, France, Mar 31, 2025.
- [C173] Xizhe Shi, Zizheng Guo, **Yibo Lin***, Runsheng Wang and Ru Huang, “[Handling Latch Loops in Timing Analysis with Improved Complexity and Divergent Loop Detection](#)”, IEEE/ACM Proceedings Design, Automation and Test in Europe (DATE), Lyon, France, Mar 31, 2025.

- [C172] Haikang Diao, Haoyi Zhang, Jiahao Song, Haoyang Luo, **Yibo Lin**, Runsheng Wang, Yuan Wang and Xiyuan Tang*, “[SEGA-DCIM: Design Space Exploration-Guided Automatic Digital CIM Compiler with Multiple Precision Support](#)”, IEEE/ACM Proceedings Design, Automation and Test in Europe (DATE), Lyon, France, Mar 31, 2025.
- [C171] Jing Mai, Chunyuan Zhao, Zuodong Zhang, Zhixiong Di, **Yibo Lin***, Runsheng Wang and Ru Huang, “[LEGALM: Efficient Legalization for Mixed-Cell-Height Circuits with Linearized Augmented Lagrangian Method](#)”, ACM International Symposium on Physical Design (ISPD), Austin, TX, Mar 16-19, 2025.
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